UT54ACS04E

Hex Inverters

December 2014 www.aeroflex.com/Logic Datasheet

FEATURES

- 0.6µm CRH CMOS Process
 - Latchup immune
- High speed
- Low power consumption
- Wide power supply operating range of 3.0V to 5.5V
- Available QML Q or V processes
- 14-lead flatpack
- UT54ACS04E SMD 5962-96516

DESCRIPTION

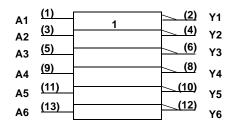
The UT54ACS04E and the UT54ACTS04E are hex inveters. The circuit performs the Boolean function $Y=\overline{A}$.

The device is characterized over full military temperature range of -55 $^{\circ}$ C to +125 $^{\circ}$ C.

FUNCTION TABLE

INPUT	OUTPUT
Α	Υ
Н	L
L	Н

LOGIC SYMBOL



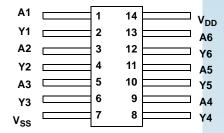
Note:

 Logic symbol in accordance with ANSI/IEEE standard 91-1984 and IEC Publication 617-12.

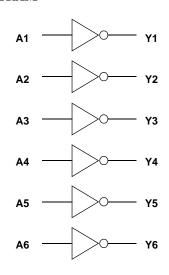


PINOUT

14-Lead Flatpack Top View



LOGIC DIAGRAM



OPERATIONAL ENVIRONMENT ¹

PARAMETER	LIMIT	UNITS
Total Dose	1.0E6	rads(Si)
SEU Threshold ²	108	MeV-cm ² /mg
SEL Threshold	120	MeV-cm ² /mg
Neutron Fluence	1.0E14	n/cm ²

Notes:

- 1. Logic will not latchup during radiation exposure within the limits defined in the table.
- 2. Device storage elements are immune to SEU affects.

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	LIMIT	UNITS
V_{DD}	Supply voltage	-0.3 to 7.0	V
V _{I/O}	Voltage any pin	$-0.3 \text{ to V}_{DD} + 0.3$	V
T _{STG}	Storage Temperature range	-65 to +150	°C
T_{J}	Maximum junction temperature	+175	°C
T_{LS}	Lead temperature (soldering 5 seconds)	+300	°C
$\Theta_{ m JC}$	Thermal resistance junction to case	15.5	°C/W
I _I	DC input current	±10	mA
P_D^2	Maximum package power dissipation permitted @ $Tc = +125^{\circ}C$	3.2	W

Note:

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMIT	UNITS
V _{DD}	Supply voltage	3.0 to 5.5	V
V _{IN}	Input voltage any pin	0 to V _{DD}	V
T _C	Temperature range	-55 to +125	°C

^{1.} Stresses outside the listed absolute maximum ratings may cause permanent damage to the device. This is a stress rating only, functional operation of the device at these or any other conditions beyond limits indicated in the operational sections is not recommended. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

^{2.} Per MIL-STD-883, method 1012.1, Section 3.4.1, $P_D = (T_{j(max)} - T_{c(max)}) \ / \ \Theta_{jc}$

DC ELECTRICAL CHARACTERISTICS FOR THE UT54ACS04E $^7\,$

 $V_{DD} = 3.3 V$ to 5.5V; $V_{SS} = 0 V^6$, -55°C < T_C < +125°C);

SYMBOL	DESCRIPTION	CONDITION	MIN	MAX	UNIT
V _{IL}	Low-level input voltage ¹	V _{DD} from 3.0V to 5.5V		0.3 V _{DD}	V
V _{IH}	High-level input voltage ¹	V _{DD} from 3.0V to 5.5V	0.7 V _{DD}		V
I _{IN}	Input leakage current	$V_{IN} = V_{DD}$ or V_{SS}	-1	1	μΑ
V _{OL}	Low-level output voltage ³	$I_{OL} = 100\mu A$ $V_{DD} = 3.0V \text{ to } 5.5V$		0.25	V
V _{OH}	High-level output voltage ³	$I_{OH} = -100\mu A$ V_{DD} from 3.0V to 5.5V	V _{DD} - 0.25		V
I _{OS1}	Short-circuit output current ² , ⁴	$V_O = V_{DD}$ and V_{SS} V_{DD} from 4.5V to 5.5V	-200	+200	mA
I _{OS2}	Short-circuit output current ² , ⁴	$V_O = V_{DD}$ and V_{SS} V_{DD} from 3.0V to 3.6V	-100	+100	mA
I _{OL1}	Low level output current ¹⁰	$V_{IN} = V_{DD}$ or V_{SS} $V_{OL} = 0.4V$ V_{DD} from 4.5V to 5.5V	+8		mA
I _{OL2}	Low level output current ¹⁰	$V_{IN} = V_{DD}$ or V_{SS} $V_{OL} = 0.4V$ V_{DD} from 3.0V to 3.6V	+6		mA
I _{OH1}	High level output current ¹⁰	$V_{IN} = V_{DD}$ or V_{SS} $V_{OH} = V_{DD}$ -0.4V V_{DD} from 4.5V to 5.5V	-8		mA
I_{OH2}	High level output current ¹⁰	$V_{IN} = V_{DD}$ or V_{SS} $V_{OH} = V_{DD}$ -0.4V V_{DD} from 3.0V to 3.6V	-6		mA
P _{total1}	Power dissipation ^{2, 8, 9}	$C_L = 50 pF$ $V_{DD} = 4.5 V$ to 5.5 V		1.0	mW/ MHz
P _{total2}	Power dissipation ^{2, 8, 9}	$C_L = 50 pF$ $V_{DD} = 3.0 V \text{ to } 3.6 V$		0.5	mW/ MHz
I _{DDQ}	Quiescent Supply Current	$V_{DD} = 5.5V$		25	μΑ
C _{IN}	Input capacitance ⁵	f = 1MHz $V_{DD} = 0$ V		15	pF

C _{OUT}	Output capacitance ⁵	f = 1MHz	15	pF
		$V_{DD} = 0V$		

Notes:

- 1. Functional tests are conducted in accordance with MIL-STD-883 with the following input test conditions: $V_{IH} = V_{IH}(min) + 20\%$, 0%; $V_{IL} = V_{IL}(max) + 0\%$, -50%, as specified herein, for TTL, CMOS, or Schmitt compatible inputs. Devices may be tested using any input voltage within the above specified range, but are guaranteed to $V_{IH}(min)$ and $V_{IL}(max)$.
- 2. Supplied as a design limit but not guaranteed or tested.
- 3. Per MIL-PRF-38535, for current density ≤5.0E5 amps/cm², the maximum product of load capacitance (per output buffer) times frequency should not exceed 3,765pF/ MHz.
- 4. Not more than one output may be shorted at a time for maximum duration of one second.
- 5. Capacitance measured for initial qualification and when design changes may affect the value. Capacitance is measured between the designated terminal and VSS at frequency of 1MHz and a signal amplitude of 50mV rms maximum.

 6. Maximum allowable relative shift equals 50mV.
- 6. Maximum anowable relative shift equals 30hV.
 7. For devices procured with a total ionizing dose tolerance guarantee, the post-irradiation performance is guaranteed at 25°C per MIL-STD-883 method 1019 condition A up to the maximum TID level procured.
 8. Power does not include power contribution of any TTL output sink current.
 9. Power dissipation specified per switching output.
 10. Guaranteed by characterization, but not tested.

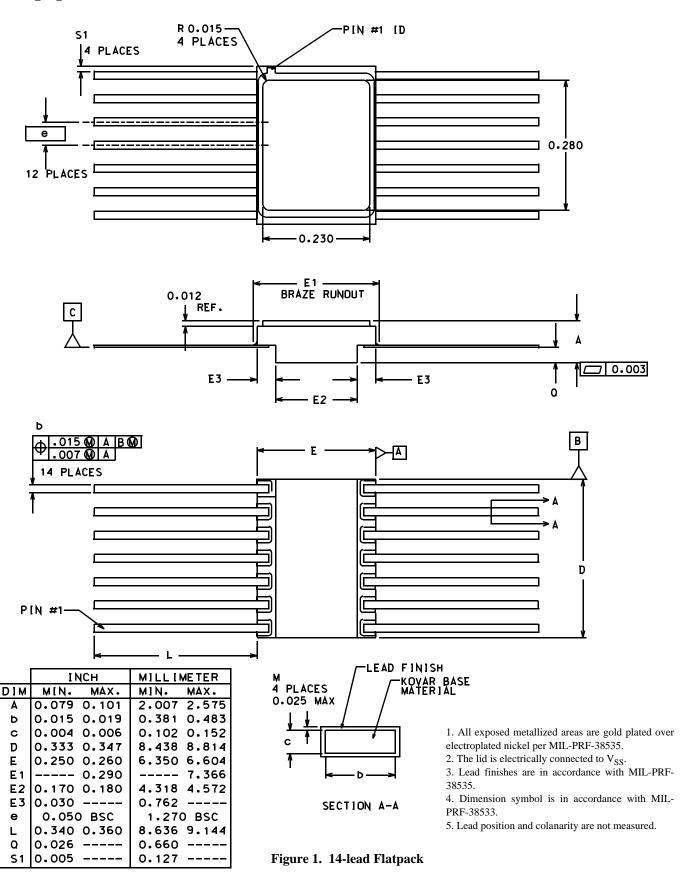
AC ELECTRICAL CHARACTERISTICS FOR THE UT54ACS04E²

 $(V_{DD} = 3.0V \ to \ 5.5V; \ V_{SS} = \ 0V^{-1}, \ \text{-}55^{\circ}C < T_{C} < +125^{\circ}C);$

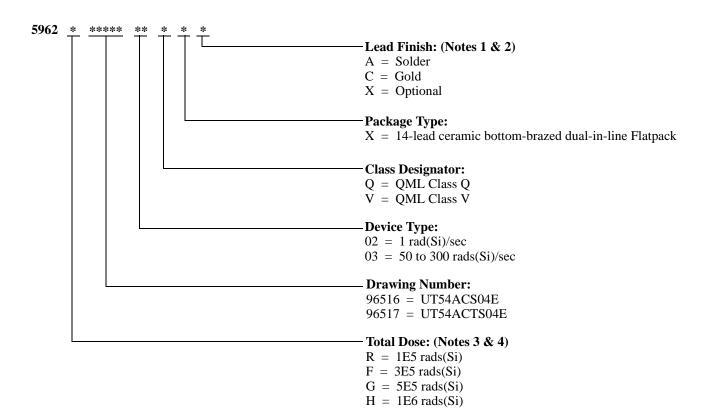
SYMBOL	PARAMETER	Condition	V_{DD}	MINIMUM	MAXIMUM	UNIT
t _{PLH}	Input to Yn	$C_L = 50pF$	4.5V to 5.5V	1	6	ns
			3.0V to 3.6V	1	8	
t _{PHL}	Input to Yn	$C_L = 50pF$	4.5V to 5.5V	1	8.5	ns
			3.0V to 3.6V	1	12.5	

^{1.} Maximum allowable relative shift equals 50mV.
2. For devices procured with a total ionizing dose tolerance guarantee, the post-irradiation performance is guaranteed at 25°C per MIL-STD-883 method 1019 condition A up to the maximum TID level procured.

Packaging



Ordering Information: UT54ACTS04E: SMD



Notes:

- 1. Lead finish (A,C, or X) must be specified.
- 2. If an "X" is specified when ordering, part marking will match the lead finish and will be either "A" (solder) or "C" (gold).
- 3. Total dose radiation must be specified when ordering. QML Q and QML V not available without radiation hardening. For prototype inquiries, contact factory.
- 4. Device type 02 is only offered with a TID tolerance guarantee of 3E5 rads(Si) or 1E6 rads(Si) and is tested in accordance with MIL-STD-883 Test Method 1019 Condition A and section 3.11.2. Device type 03 is only offered with a TID tolerance guarantee of 1E5 rads(Si), 3E5 rads(Si), and 5E5 rads(Si), and is tested in accordance with MIL-STD-883 Test Method 1019 Condition A.

Aeroflex Colorado Springs - Datasheet Definition

Advanced Datasheet - Product In Development

Preliminary Datasheet - Shipping Prototype

Datasheet - Shipping QML & Reduced HiRel

This product is controlled for export under the U.S. Department of Commerce (DoC). A license may be required prior to the export of this product from the United States.

www.aeroflex.com info-ams@aeroflex.com



Aeroflex Colorado Springs (Aeroflex) reserves the right to make changes to any products and services herein at any time without notice. Consult Aeroflex or an authorized sales representative to verify that the information in this data sheet is current before using this product. Aeroflex does not assume any responsibility or liability arising out of the application or use of any product or service described herein, except as expressly agreed to in writing by Aeroflex; nor does the purchase, lease, or use of a product or service from Aeroflex convey a license under any patent rights, copyrights, trademark rights, or any other of the intellectual rights of Aeroflex or of third parties.







Our passion for performance is defined by three attributes represented by these three icons: solution-minded, performance-driven and customer-focused

Datasheet Revision History

Revision Date	Description of Change
December 2014 Version 0.1.0	Initial Release of Advanced Data Sheet